

# PJQ45816P-AU

## 80V N-Channel Enhancement Mode MOSFET

**Voltage**    **80 V**    **Current**    **33 A**

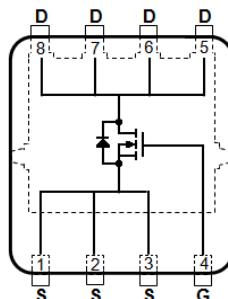
### Features

- $R_{DS(ON)}$ ,  $V_{GS} @ 10V$ ,  $I_D @ 8A < 23.5m\Omega$
- $R_{DS(ON)}$ ,  $V_{GS} @ 7V$ ,  $I_D @ 4A < 30.5m\Omega$
- Excellent FOM
- Standard Level Drive
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

### Mechanical Data

- Case : DFN3333-8L Package
- Terminals : Solderable per MIL-STD-750, Method 2026
- Approx. Weight : 0.03 grams

DFN3333-8L



### Maximum Ratings and Thermal Characteristics ( $T_A=25^\circ C$ unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNITS
Drain-Source Voltage	$V_{DS}$	80	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current <sup>(Note 3)</sup>	$I_D$	33	A
		23	
Pulsed Drain Current <sup>(Note 1)</sup>	$I_{DM}$	80	W
Power Dissipation	$P_D$	50	
		25	
Continuous Drain Current <sup>(Note 4)</sup>	$I_D$	8.4	A
		7.0	
Power Dissipation	$P_D$	3.3	W
		2.3	
Single Pulse Avalanche Current <sup>(Note 5)</sup>	$I_{AS}$	6	A
Single Pulse Avalanche Energy <sup>(Note 5)</sup>	$E_{AS}$	16	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55~175	°C
Thermal Resistance <sup>(Note 4)</sup>	Junction to Case	$R_{\theta JC}$	°C/W
	Junction to Ambient	$R_{\theta JA}$	

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## Electrical Characteristics ( $T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
<b>Static</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	80	-	-	V
Gate Threshold Voltage	$\text{V}_{\text{GS(th)}}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$	2	-	3.8	
Drain-Source On-State Resistance	$\text{R}_{\text{DS(on)}}$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=8\text{A}$	-	19	23.5	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=7\text{V}, \text{I}_D=4\text{A}$	-	23.2	30.5	
Zero Gate Voltage Drain Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=80\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
Gate-Source Leakage Current	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}}=\pm 20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	nA
<b>Dynamic</b> <sup>(Note 6)</sup>						
Total Gate Charge	$\text{Q}_g$	$\text{V}_{\text{DS}}=40\text{V}, \text{I}_D=15\text{A}, \text{V}_{\text{GS}}=10\text{V}$ <sup>(Note 2)</sup>	-	6.7	9	nC
Gate-Source Charge	$\text{Q}_{\text{gs}}$		-	2.7	-	
Gate-Drain Charge	$\text{Q}_{\text{gd}}$		-	1.2	-	
Input Capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{DS}}=40\text{V}, \text{V}_{\text{GS}}=0\text{V}, f=1\text{MHz}$	-	373	559	pF
Output Capacitance	$\text{C}_{\text{oss}}$		-	178	267	
Reverse Transfer Capacitance	$\text{Crss}$		-	6	11	
Gate resistance	$\text{R}_g$	$f=1\text{MHz}$	-	1.1	2.2	$\Omega$
Turn-On Delay Time	$\text{td}_{(\text{on})}$	$\text{V}_{\text{DS}}=40\text{V}, \text{I}_D=15\text{A}, \text{V}_{\text{GS}}=10\text{V}, \text{R}_g=2.5\Omega$ <sup>(Note 2)</sup>	-	5.8	-	ns
Turn-On Rise Time	$\text{tr}$		-	1.6	-	
Turn-Off Delay Time	$\text{td}_{(\text{off})}$		-	8.1	-	
Turn-Off Fall Time	$\text{tf}$		-	2.1	-	
<b>Drain-Source Diode</b>						
Diode Forward Current	$\text{I}_s$	$\text{T}_{\text{C}}=25^\circ\text{C}$ (Package Limit)	-	-	33	A
Pulsed Diode Forward Current	$\text{I}_{\text{sm}}$		-	-	80	
Diode Forward Voltage	$\text{V}_{\text{SD}}$	$\text{I}_s=8\text{A}, \text{V}_{\text{GS}}=0\text{V}$	-	0.9	1.2	V
Reverse Recovery Time	$\text{Tr}_{\text{r}}$	$\text{V}_{\text{DD}}=40\text{V} \text{ V}_{\text{GS}}=0\text{V}, \text{I}_s=15\text{A}, \text{dI}_s/\text{dt}=100\text{A}/\text{us}$	-	22.6	-	ns
Reverse Recovery Charge	$\text{Q}_{\text{rr}}$		-	15.8	-	nC

### NOTES :

1. Pulse width  $\leq 100\text{us}$ , Duty cycle  $\leq 2\%$ .
2. Essentially independent of operating temperature typical characteristics.
3. Chip capability with an  $R_{\text{eJC}}=3^\circ\text{C/W}$ .
4.  $R_{\text{eJA}}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch<sup>2</sup> with 2oz.square pad of copper.
5.  $E_{\text{AS}}$  is calculated based on the condition of  $L=1\text{mH}, I_{\text{AS}}=5.6\text{A}, V_{\text{DD}}=30\text{V}, V_{\text{GS}}=10\text{V}$ . 100% test at  $L=0.5\text{mH}, I_{\text{AS}}=6\text{A}$  in production.
6. Guaranteed by design, not subject to production testing.

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## TYPICAL CHARACTERISTIC CURVES

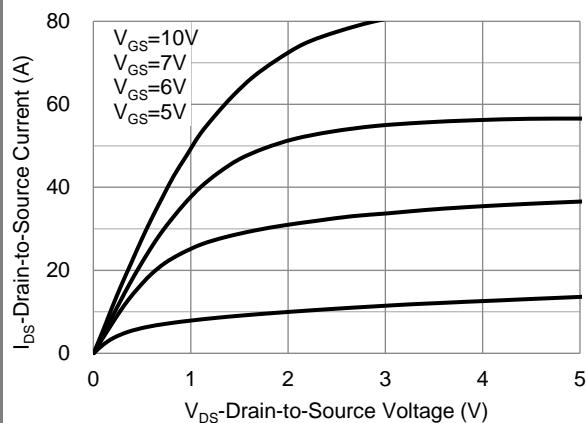


Fig.1 On-Region Characteristics

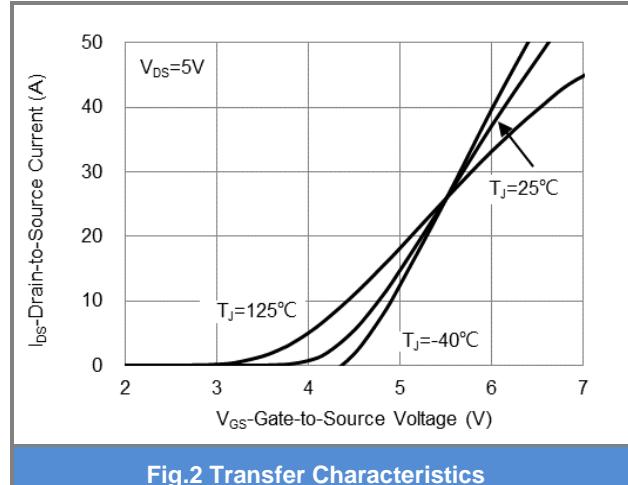


Fig.2 Transfer Characteristics

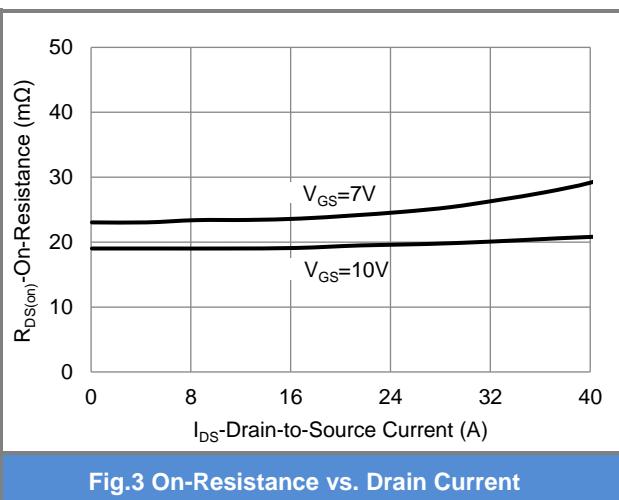


Fig.3 On-Resistance vs. Drain Current

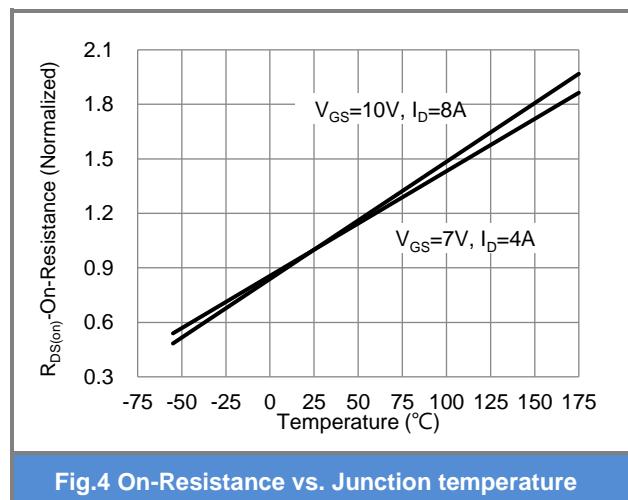


Fig.4 On-Resistance vs. Junction temperature

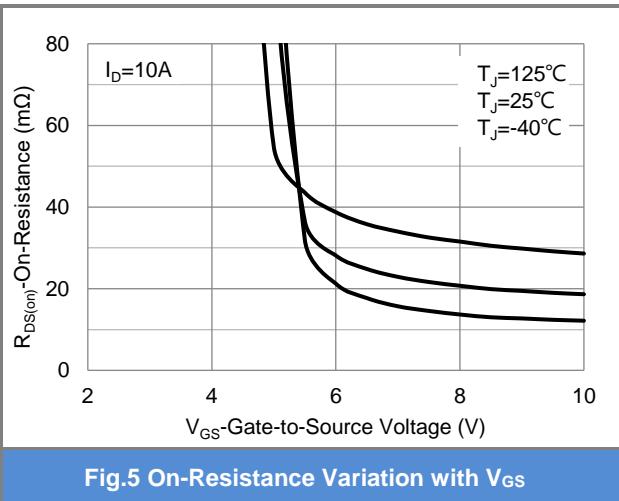


Fig.5 On-Resistance Variation with V<sub>G</sub>

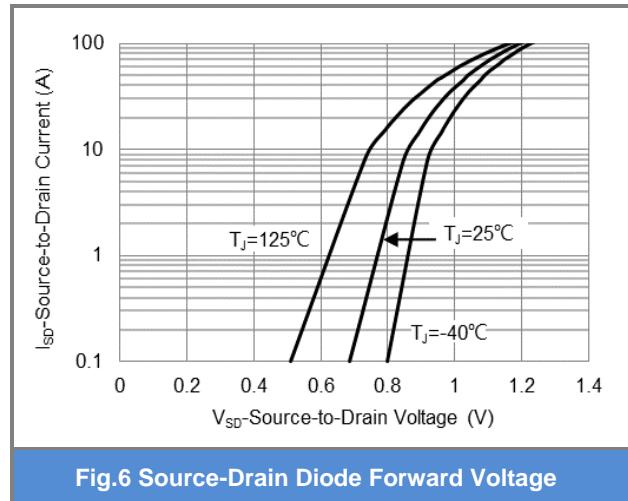


Fig.6 Source-Drain Diode Forward Voltage

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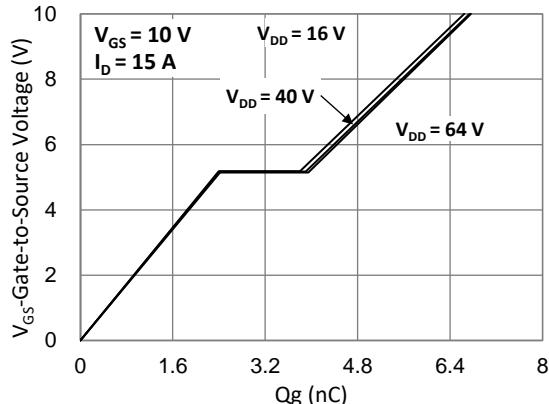


Fig.7 Gate-Charge Characteristics

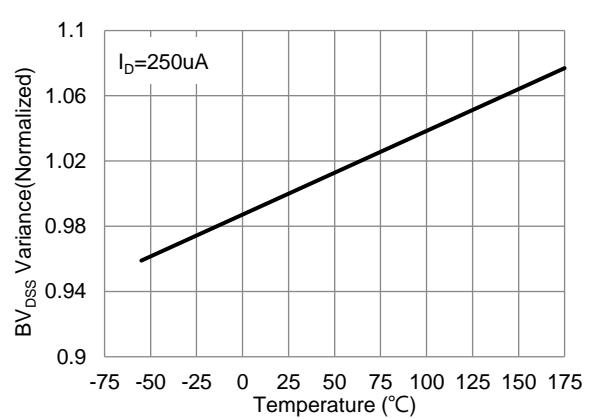


Fig.8 Breakdown Voltage Variation vs. Temperature

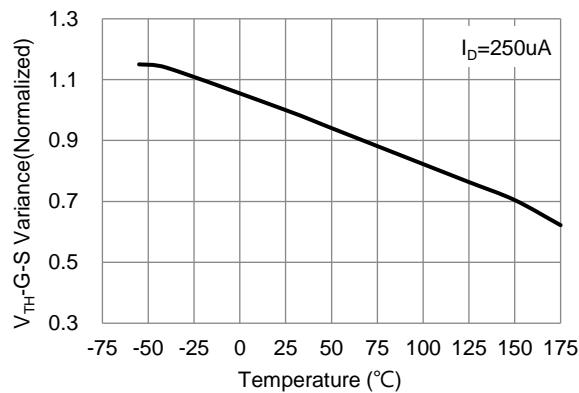


Fig.9 Threshold Voltage Variation with Temperature

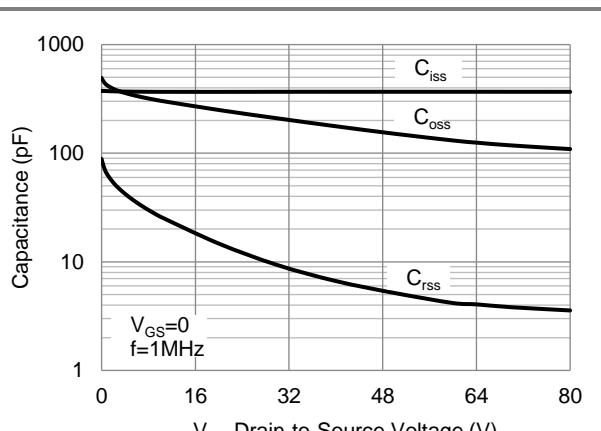


Fig.10 Capacitance vs. Drain-Source Voltage

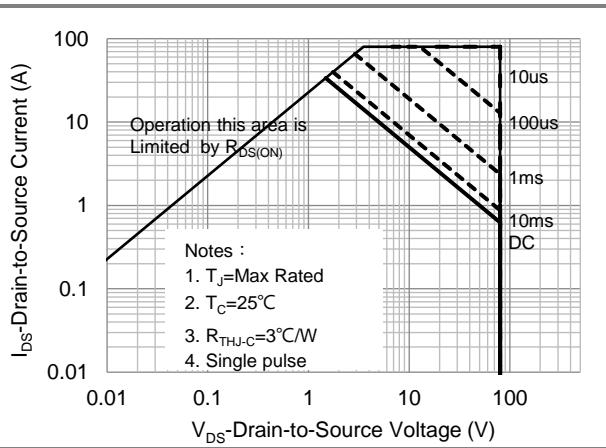


Fig.11 Maximum Safe Operating Area

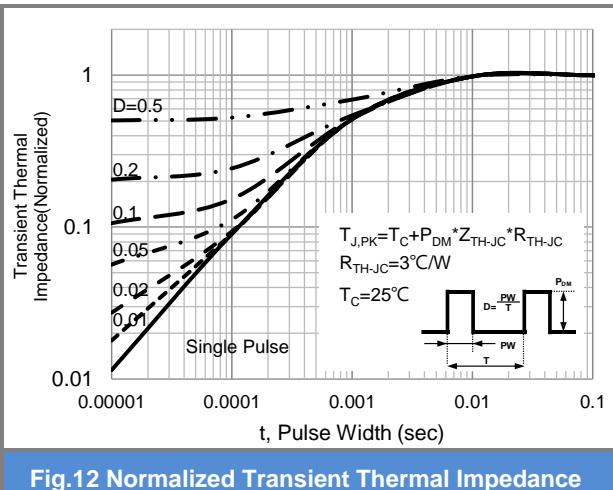


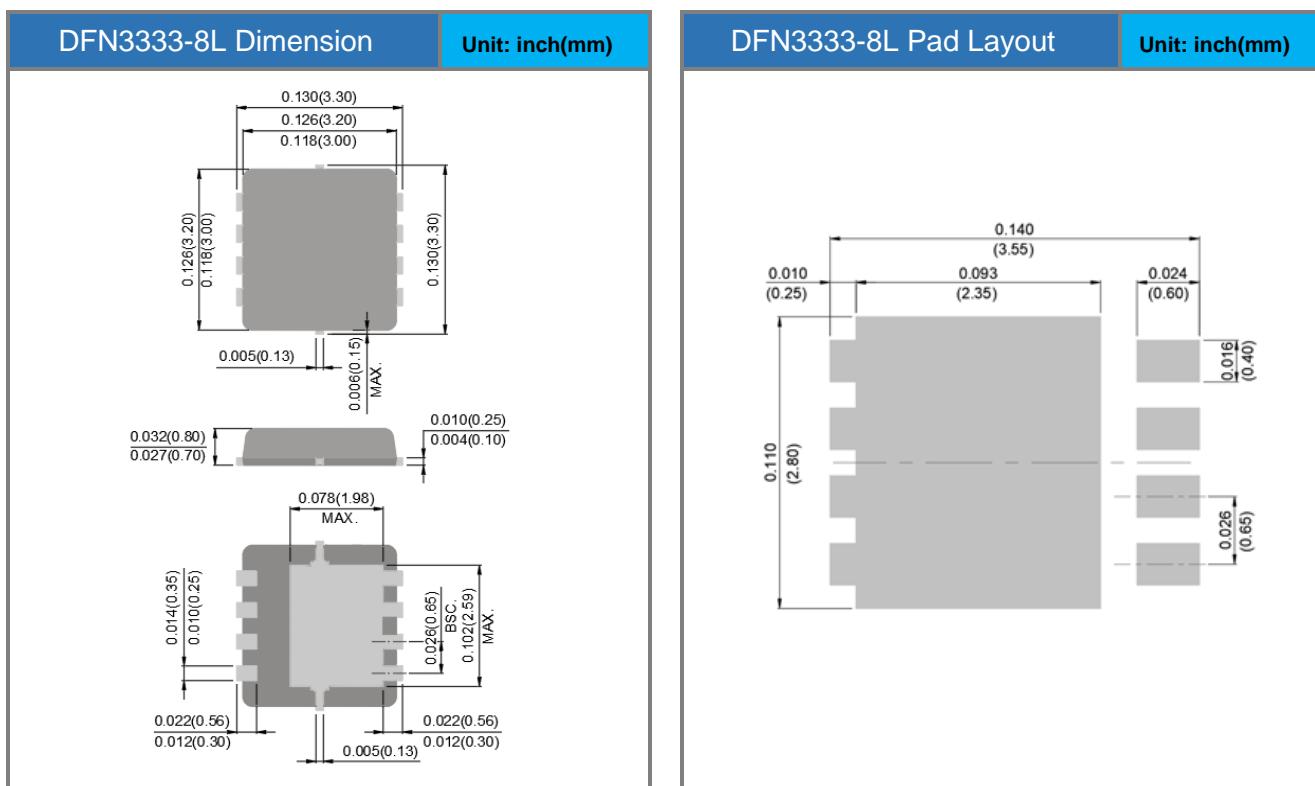
Fig.12 Normalized Transient Thermal Impedance

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## Product and Packing Information

Part No.	Package Type	Packing Type	Marking
PJQ45816P-AU	DFN3333-8L	5K pcs / 13" reel	45816

## Packaging Information & Mounting Pad Layout



## **PJQ45816P-AU**

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